

Hybrid Power Module

Integrated Power Stage for 230 VAC Motor Drives

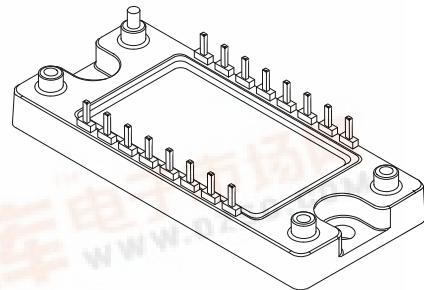
These VersaPower™ modules integrate a 3-phase inverter in a single convenient package. They are designed for 1.0 and 2.0 hp motor drive applications. The inverter incorporates advanced insulated gate bipolar transistors (IGBT) matched with free-wheeling diodes to give optimum performance. The top connector pins are designed for easy interfacing to the user's control board.

- Short Circuit Rated 10 μ s @ 25°C, 300 V
- Pin-to-Baseplate Isolation Exceeds 2500 Vac (rms)
- Compact Package Outline
- Access to Positive and Negative DC Bus
- UL  Recognized
- Visit our website at <http://www.mot-sps.com/tsg/>

MHPM6B10A60D MHPM6B20A60D

Motorola Preferred Devices

10, 20 AMP, 600 V
HYBRID POWER MODULES



CASE 464-03
ISSUE B

MAXIMUM DEVICE RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
IGBT Reverse Voltage	V_{CES}	600	V
Gate-Emitter Voltage	V_{GES}	± 20	V
Continuous IGBT Collector Current 10A60 20A60	I_{Cmax}	10 20	A
Repetitive Peak IGBT Collector Current (1) 10A60 20A60	$I_{C(pk)}$	20 40	A
Continuous Free-Wheeling Diode Current 10A60 20A60	I_{Fmax}	10 20	A
Repetitive Peak Free-Wheeling Diode Current (1) 10A60 20A60	$I_{F(pk)}$	20 40	A
IGBT Power Dissipation ($T_C = 25^\circ\text{C}$) 10A60 20A60	P_D	52 78	W
Diode Power Dissipation ($T_C = 25^\circ\text{C}$) 10A60 20A60	P_D	19 38	W
IGBT Power Dissipation ($T_C = 95^\circ\text{C}$) 10A60 20A60	P_D	23 34	W
Diode Power Dissipation ($T_C = 95^\circ\text{C}$) 10A60 20A60	P_D	8.3 17	W
Junction Temperature Range	T_J	-40 to +150	°C
Short Circuit Duration ($V_{CE} = 300$ V, $T_J = 25^\circ\text{C}$)	t_{sc}	10	μs
Isolation Voltage	V_{ISO}	2500	Vac
Operating Case Temperature Range	T_C	-40 to +95	°C
Storage Temperature Range	T_{stg}	-40 to +125	°C
Mounting Torque — Heat Sink Mounting Holes (#8 or M4 screws)	—	12	in-lb

(1) 1.0 ms = 1.0% duty cycle

Preferred devices are Motorola recommended choices for future use and best overall value.

VersaPower is a trademark of Motorola, Inc.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
DC AND SMALL SIGNAL CHARACTERISTICS					
Gate-Emitter Leakage Current ($V_{CE} = 0 \text{ V}$, $V_{GE} = \pm 20 \text{ V}$)	I_{GES}	—	—	± 20	μA
Collector-Emitter Leakage Current ($V_{CE} = 600 \text{ V}$, $V_{GE} = 0 \text{ V}$) $T_J = 125^\circ\text{C}$	I_{CES}	—	6.0 2000	100	μA
Gate-Emitter Threshold Voltage ($V_{CE} = V_{GE}$, $I_C = 1.0 \text{ mA}$)	$V_{GE(\text{th})}$	4.0	6.0	8.0	V
Collector-Emitter Breakdown Voltage ($I_C = 10 \text{ mA}$, $V_{GE} = 0 \text{ V}$)	$V_{(\text{BR})CES}$	600	—	—	V
Collector-Emitter Saturation Voltage ($I_C = I_{C\text{max}}$, $V_{GE} = 15 \text{ V}$) $T_J = 125^\circ\text{C}$	$V_{CE(\text{SAT})}$	— —	2.35 2.31	3.5	V
Diode Forward Voltage ($I_F = I_{F\text{max}}$, $V_{GE} = 0 \text{ V}$) $T_J = 125^\circ\text{C}$	V_F	— —	1.23 1.12	2.0	V
Input Capacitance ($V_{CE} = 10 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$) 10A60 20A60	C_{ies}	— —	2300 4400	—	pF
Input Gate Charge ($V_{CE} = 300 \text{ V}$, $I_C = I_{C\text{max}}$, $V_{GE} = 15 \text{ V}$) 10A60 20A60	Q_T	— —	75 135	—	nC

INDUCTIVE SWITCHING CHARACTERISTICS ($T_J = 25^\circ\text{C}$)

Recommended Gate Resistor					
Turn-On	10A60 20A60	$R_{G(\text{on})}$	— —	180 47	—
Turn-Off		$R_{G(\text{off})}$	—	20	—
Turn-On Delay Time ($V_{CE} = 300 \text{ V}$, $I_C = I_{C\text{max}}$, $V_{GE} = 15 \text{ V}$, R_G as specified)	10A60 20A60	$t_{d(\text{on})}$	— —	375 215	—
Rise Time ($V_{CE} = 300 \text{ V}$, $I_C = I_{C\text{max}}$, $V_{GE} = 15 \text{ V}$, R_G as specified)	10A60 20A60	t_r	— —	160 125	—
Turn-Off Delay Time ($V_{CE} = 300 \text{ V}$, $I_C = I_{C\text{max}}$, $V_{GE} = 15 \text{ V}$, R_G as specified)		$t_{d(\text{off})}$	—	219	—
Fall Time ($V_{CE} = 300 \text{ V}$, $I_C = I_{C\text{max}}$, $V_{GE} = 15 \text{ V}$, R_G as specified)		t_f	—	210	500
Turn-On Energy ($V_{CE} = 300 \text{ V}$, $I_C = I_{C\text{max}}$, $V_{GE} = 15 \text{ V}$, R_G as specified)	10A60 20A60	E_{on}	— —	0.85 1.6	1.0 2.0
Turn-Off Energy ($V_{CE} = 300 \text{ V}$, $I_C = I_{C\text{max}}$, $V_{GE} = 15 \text{ V}$, R_G as specified)	10A60 20A60	E_{off}	— —	0.17 0.4	1.0 2.0
Diode Reverse Recovery Time ($I_F = I_{F\text{max}}$, $V = 300 \text{ V}$, R_G as specified)		t_{rr}	—	150	—
Peak Reverse Recovery Current ($I_F = I_{F\text{max}}$, $V = 300 \text{ V}$, R_G as specified)	10A60 20A60	I_{rrm}	— —	6.8 12	—
Diode Stored Charge ($I_F = I_{F\text{max}}$, $V = 300 \text{ V}$, R_G as specified)	10A60 20A60	Q_{rr}	— —	560 1060	—

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INDUCTIVE SWITCHING CHARACTERISTICS (T_J = 125°C)

Characteristic	Symbol	Min	Typ	Max	Unit
Turn-On Delay Time (V _{CE} = 300 V, I _C = I _{Cmax} , V _{GE} = 15 V, R _G as specified) 10A60 20A60	t _{d(on)}	— —	335 200	— —	ns
Rise Time (V _{CE} = 300 V, I _C = I _{Cmax} , V _{GE} = 15 V, R _G as specified) 10A60 20A60	t _r	— —	160 125	— —	ns
Turn-Off Delay Time (V _{CE} = 300 V, I _C = I _{Cmax} , V _{GE} = 15 V, R _G as specified)	t _{d(off)}	—	230	—	ns
Fall Time (V _{CE} = 300 V, I _C = I _{Cmax} , V _{GE} = 15 V, R _G as specified)	t _f	—	460	—	ns
Turn-On Energy (V _{CE} = 300 V, I _C = I _{Cmax} , V _{GE} = 15 V, R _G as specified) 10A60 20A60	E _{on}	— —	1.2 2.2	— —	mJ
Turn-Off Energy (V _{CE} = 300 V, I _C = I _{Cmax} , V _{GE} = 15 V, R _G as specified) 10A60 20A60	E _{off}	— —	0.44 0.82	— —	mJ
Diode Reverse Recovery Time (I _F = I _{Fmax} , V = 300 V, R _G as specified)	t _{rr}	—	240	—	ns
Peak Reverse Recovery Current (I _F = I _{Fmax} , V = 300 V, R _G as specified) 10A60 20A60	I _{rrm}	— —	10 18	— —	A
Diode Stored Charge (I _F = I _{Fmax} , V = 300 V, R _G as specified) 10A60 20A60	Q _{rr}	— —	1330 2400	— —	nC

THERMAL CHARACTERISTICS (Each Die)

Thermal Resistance — IGBT 10A60 20A60	R _{θJC}	— —	1.94 1.28	2.43 1.60	°C/W
Thermal Resistance — Free-Wheeling Diode 10A60 20A60	R _{θJC}	— —	5.28 2.61	6.60 3.26	°C/W

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TYPICAL CHARACTERISTICS

(see also application information)

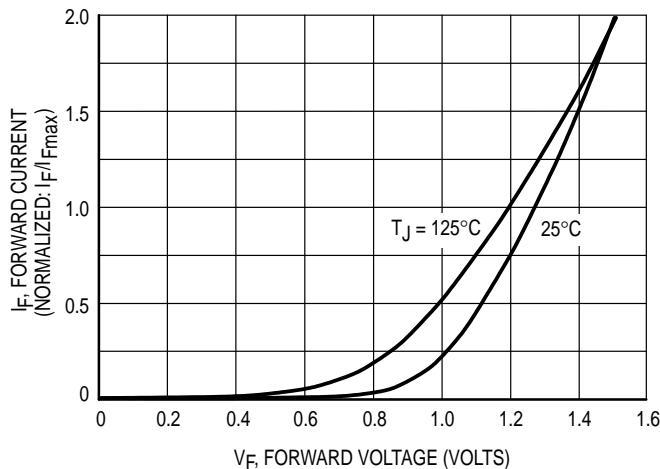


Figure 1. Forward Characteristics — Free-Wheeling Diode

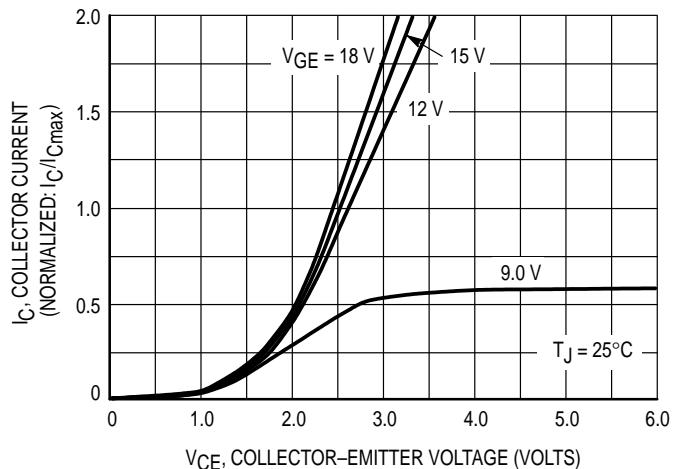


Figure 2. Forward Characteristics, $T_J = 25^\circ\text{C}$

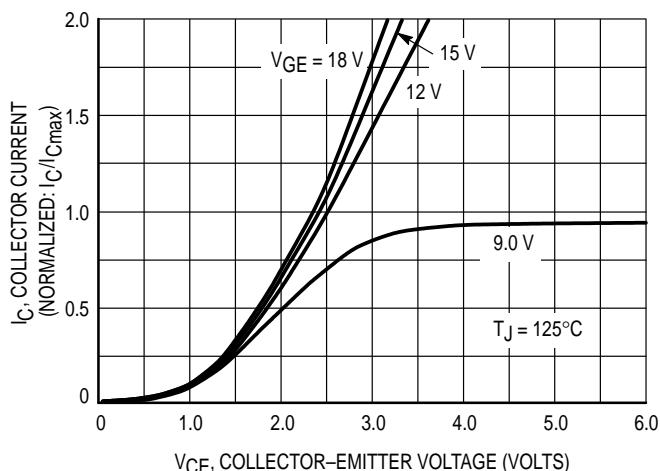


Figure 3. Forward Characteristics, $T_J = 125^\circ\text{C}$

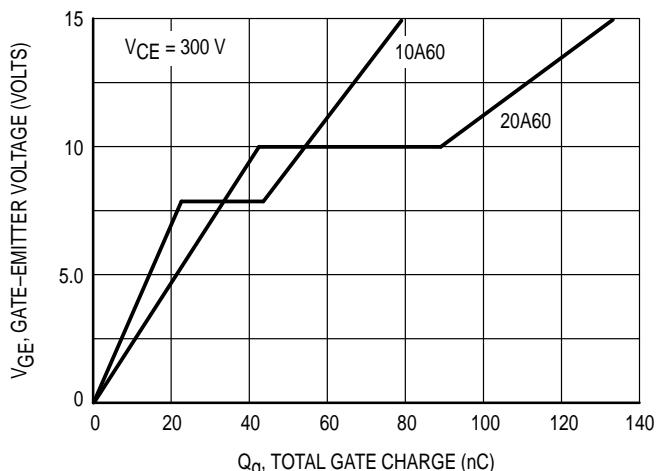


Figure 4. Gate-Emitter Voltage versus Total Gate Charge

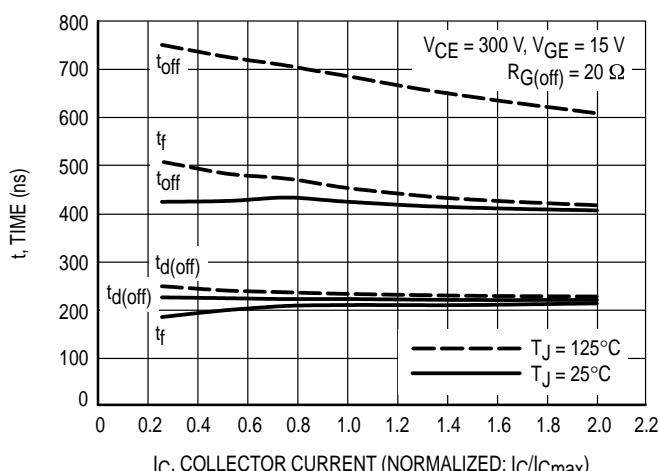


Figure 5. Inductive Switching Times versus Collector Current

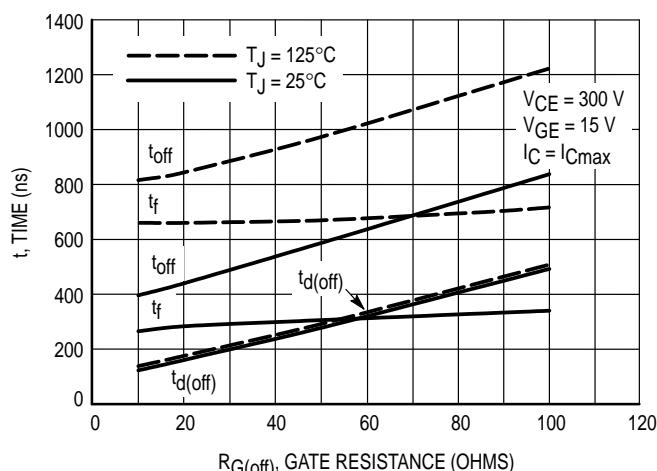


Figure 6. Inductive Switching Times versus Gate Resistance

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TYPICAL CHARACTERISTICS

(see also application information)

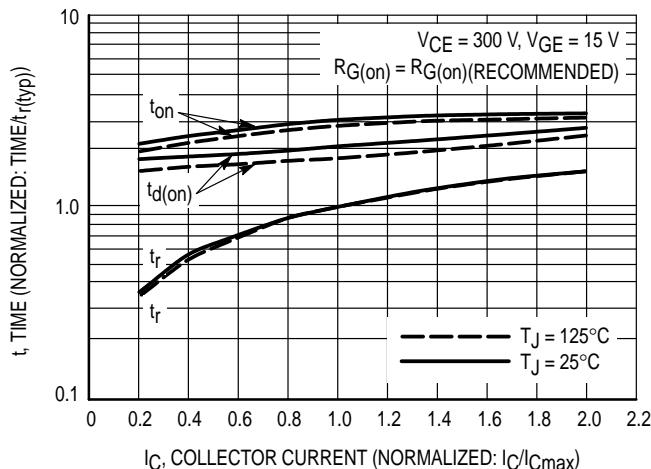


Figure 7. Inductive Switching Times versus Collector Current

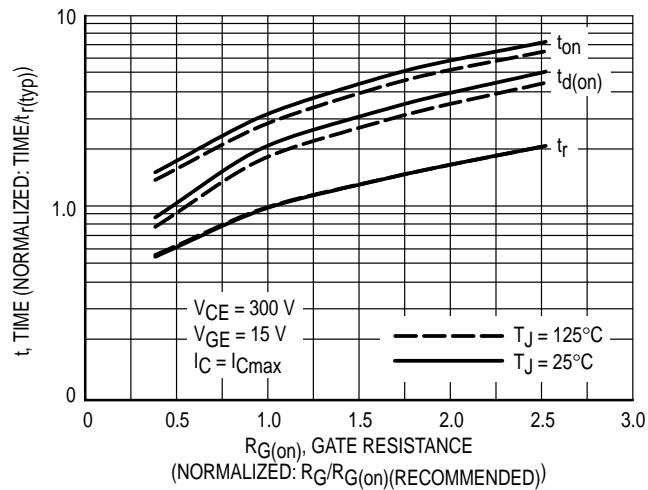


Figure 8. Inductive Switching Times versus Gate Resistance

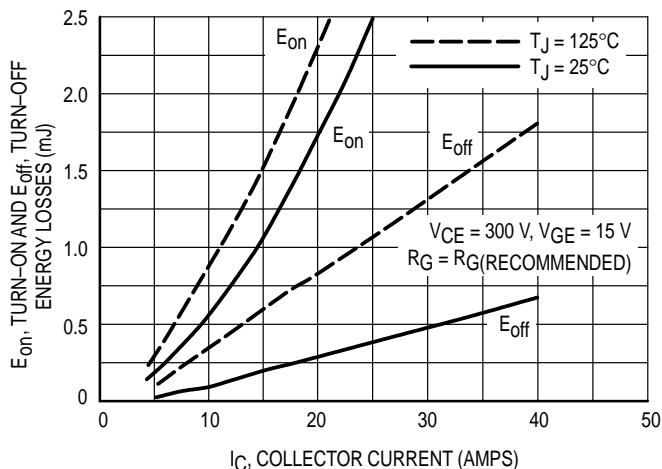


Figure 9. Turn-On and Turn-Off Energy Losses versus Collector Current

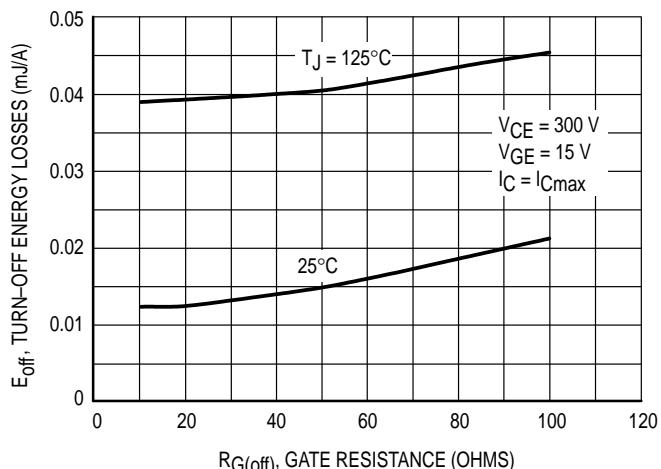


Figure 10. Turn-Off Energy Losses versus Gate Resistance

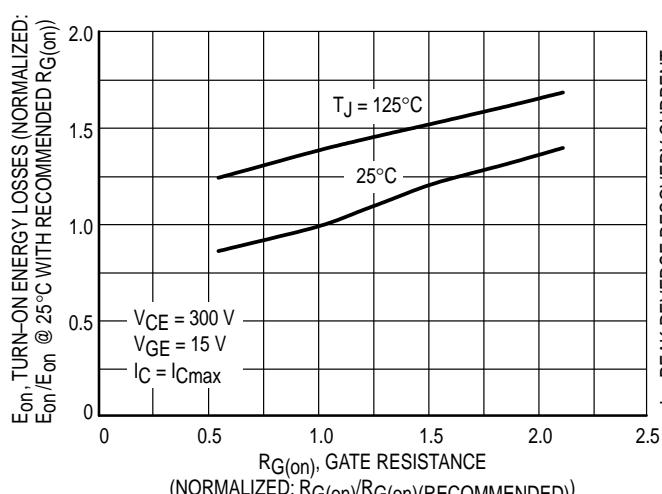


Figure 11. Turn-On Energy Losses versus Gate Resistance

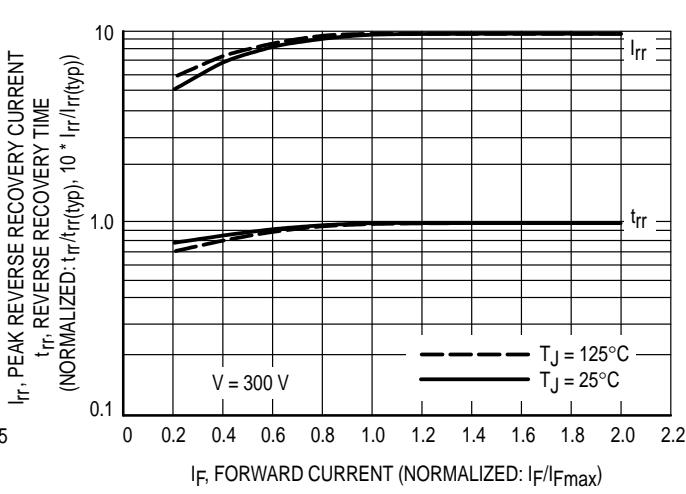


Figure 12. Reverse Recovery Characteristics — Free-Wheeling Diode

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TYPICAL CHARACTERISTICS

(see also application information)

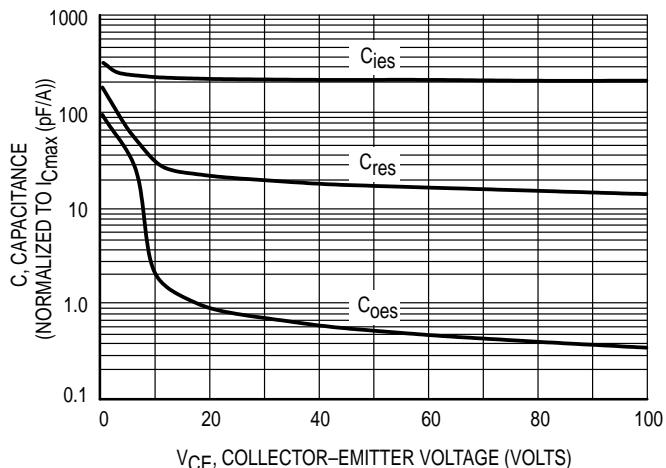


Figure 13. Capacitance Variation

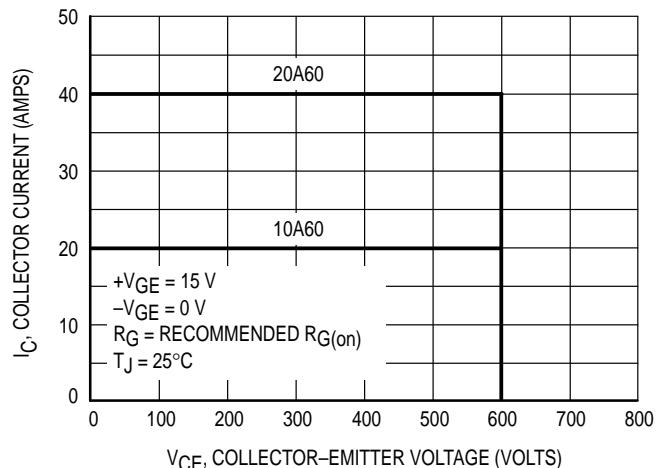


Figure 14. Reverse Biased Safe Operating Area (RBSOA)

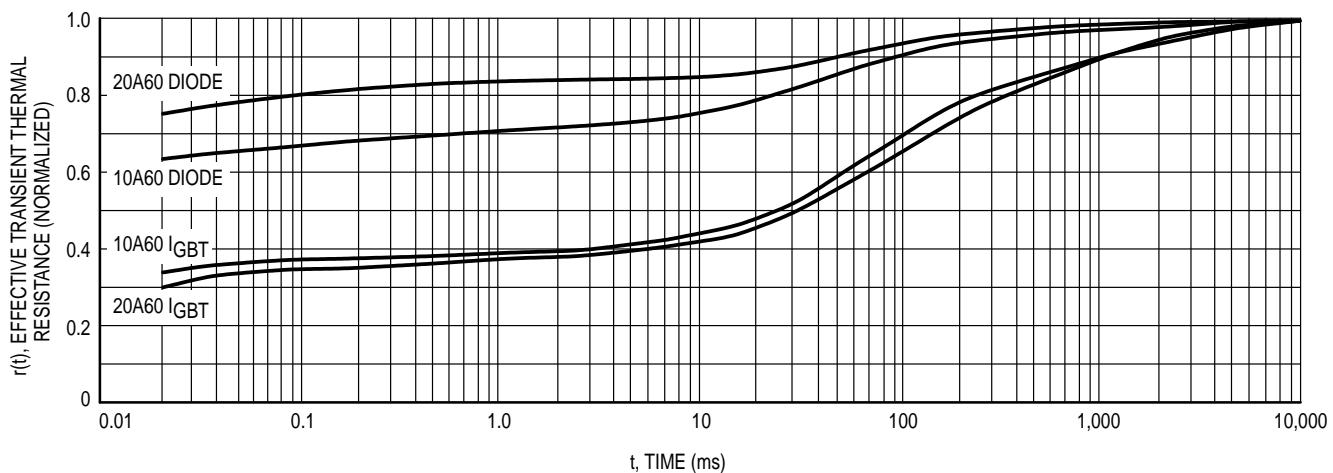


Figure 15. Thermal Response

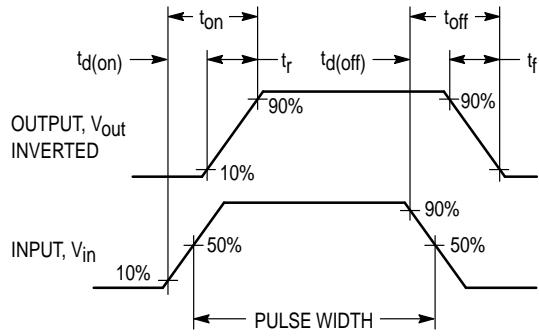


Figure 16. Switching Waveforms

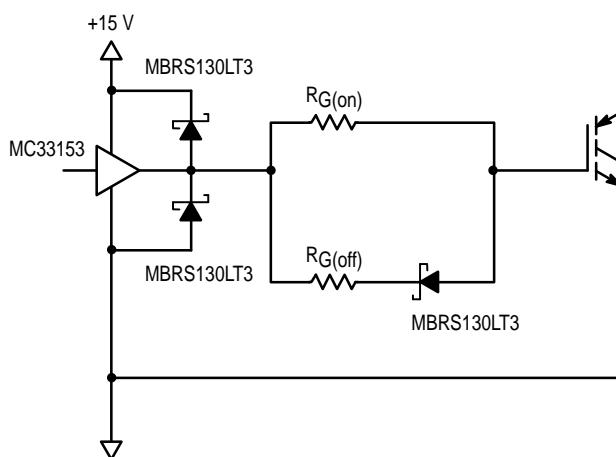


Figure 17. Recommended Gate Drive Circuit

APPLICATION INFORMATION

These modules are designed to be used as the power stage of a three-phase AC induction motor drive. They may be used for up to 230 VAC applications. Switching frequencies up to 10 kHz have been considered in the design.

Gate resistance recommendations have been listed. Separate turn-on and turn-off resistors are listed, to be used in a circuit resembling Figure 17. All switching characteristics are given based on following these recommendations, but appropriate graphs are shown for operation with different gate resistance. In order to equalize across the two different module ratings, a normalization process was used. Actual typical values are listed in the second section of this specification sheet, "Electrical Specifications," but many of the graphs are given in normalized units.

The first three graphs, the DC characteristics, are normalized for current. The devices are designed to operate the same at rated maximum current (10 and 20 A). The curves extend to $I_C(pk)$, the maximum allowable instantaneous current.

The next graph, turn-off times versus current, is again normalized to the rated maximum current. The following graph, turn-off times versus $R_G(\text{off})$, is intentionally not normalized, as both modules behave similarly during turn-off.

Turn-on times have been normalized. Again, the graph showing variation due to current has been normalized for rated maximum current. The graph showing variation due to gate resistance normalizes against the recommended $R_G(\text{on})$ for each module. In addition, the times are normalized to t_r at the appropriate temperature. For example, $t_{d(on)}$ for a 10 A module operating at 125°C at 4.0 A can be found by multiplying the typical t_r for a 10 A module at 125°C (160 ns) by the value shown on the graph at a normalized current of 0.4 (1.6) to get 256 ns. The most salient features demonstrated by these graphs are the general trends: rise time is a larger fraction

of total turn-on time at 125°C, and in general, larger gate resistance results in slower switching.

Graphs of switching energies follow a similar structure. The first of these graphs, showing variation due to current, is not normalized, as any of these devices operating within its limits follows the same trend. E_{off} does not need to be normalized to show variation with $R_G(\text{off})$, as both are specified with the same nominal resistance. E_{on} , however, has been appropriately normalized. Gate resistance has been normalized to the recommended $R_G(\text{on})$. In order to show the effect of elevated temperature, all energies were normalized to E_{on} at 25°C using the recommended $R_G(\text{on})$.

Reverse recovery characteristics are also normalized. I_F is normalized to rated maximum current. I_{rrm} is normalized so that at maximum current at either 25°C or 125°C, the graph indicates "10", while t_{rr} is normalized to be "1" at maximum current at either temperature.

Capacitance values are normalized for $I_{C\text{max}}$. Due to poor scaling, gate charge and thermal characteristics are shown separately for each module.

Many issues must be considered when doing PCB layout. Figure 19 shows the footprint of a module, allowing for reasonable tolerances. A polarizing post is provided near pin 1 to ensure that the module is properly inserted during final assembly. When laying out traces, two issues are of primary importance: current carrying capacity and voltage clearance. Many techniques may be used to maximize both, including using traces on both sides of the PCB to double total copper thickness, providing cut-outs in high-current traces near high-voltage pins, and even removing portions of the board to increase "over-the-surface" creepage distance. Some additional advantage may be gained by potting the entire board assembly in a good dielectric. Consult appropriate regulatory standards, such as UL 840, for more details on high-voltage creepage and clearance.

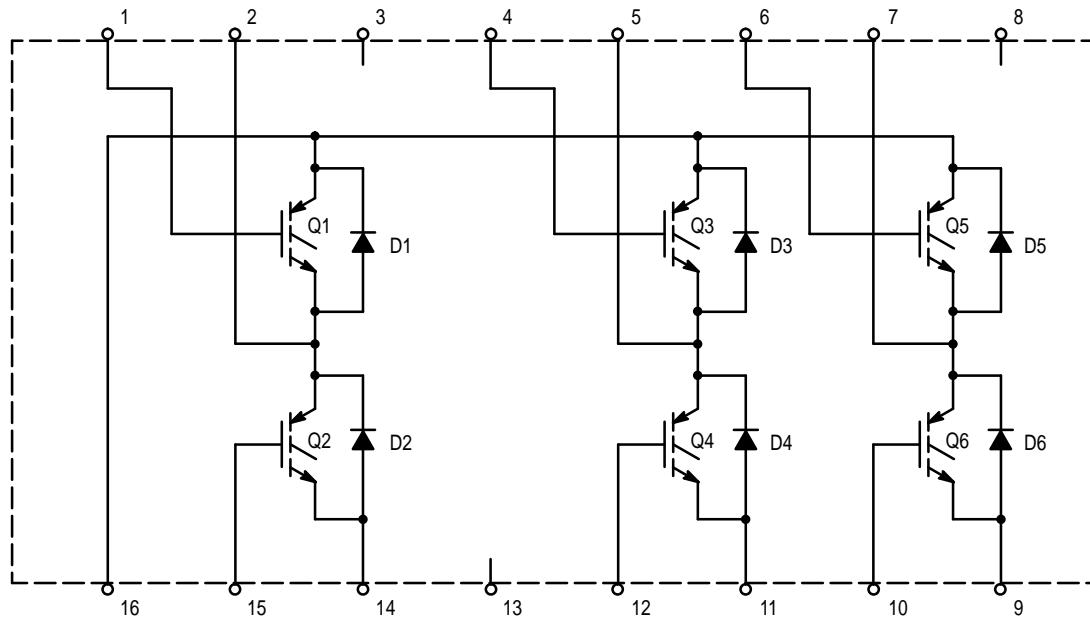


Figure 18. Schematic of Internal Circuit, Showing Package Pin-Out

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RECOMMENDED PCB LAYOUT
VIEW OF BOARD FROM HEAT SINK
(All Dimensions Typical)

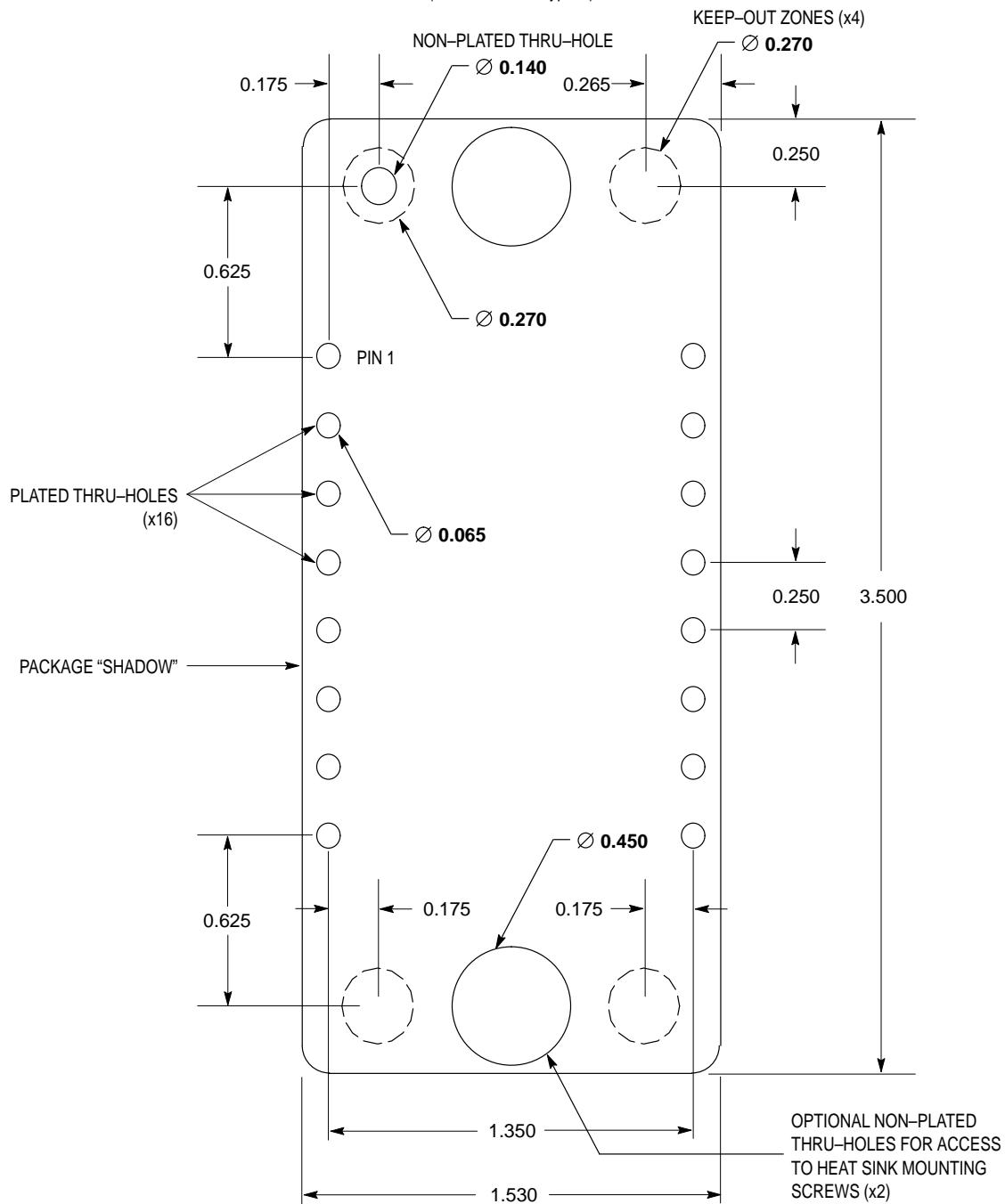


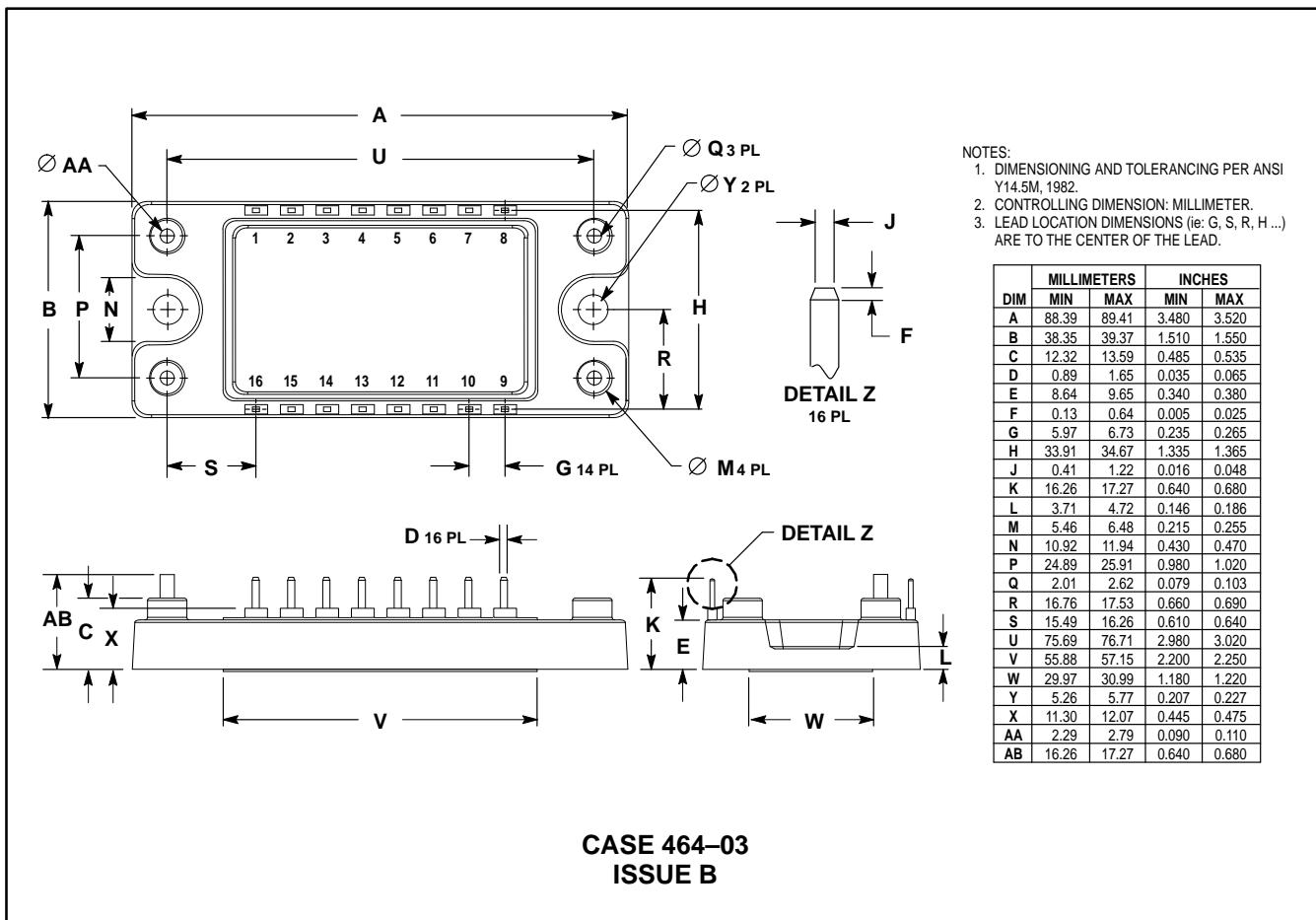
Figure 19. Package Footprint

NOTE:

1. Package is symmetrical, except for a polarizing plastic post near pin 1, indicated by a non-plated thru-hole in the footprint.
2. Dimension of plated thru-holes indicates finished hole size after plating.
3. Access holes for mounting screws may or may not be necessary depending on assembly plan for finished product.

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PACKAGE DIMENSIONS



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